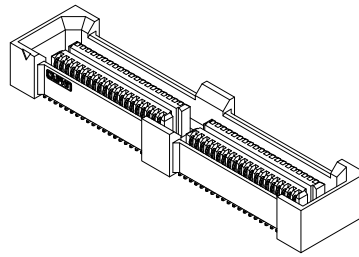


REV.	SPECIFICATION	ECN NO.	APPD.
R3		ECN240111	



Material and Plating:

Housing: LCP, UL94V-0, Black.

Signal Contacts : High Performance Copper Alloy.
Gold Plated on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min .

Electrical Characteristics:

Current Rating: 2A .

Voltage Rating: 125V AC .

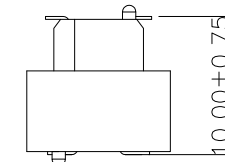
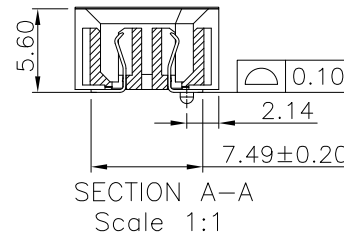
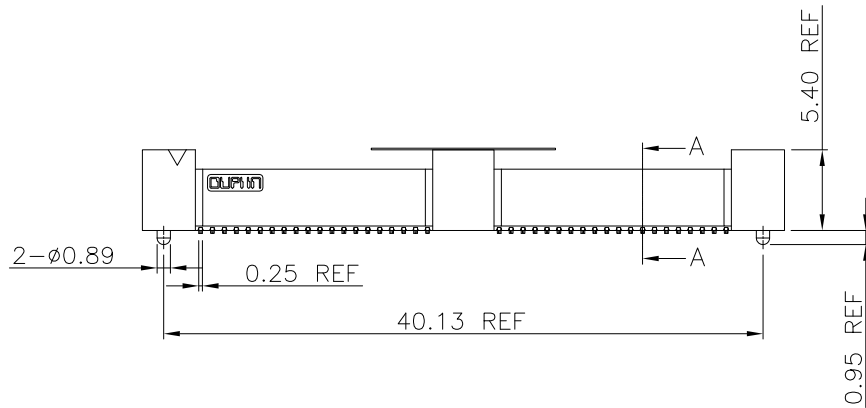
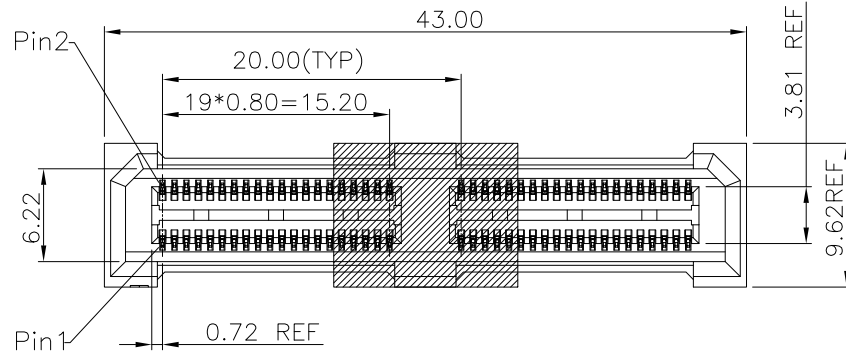
Dielectric Withstanding Voltage: 525V AC For 1 minute.

Insulator Resistance: 5000MΩ min at DC 500V.

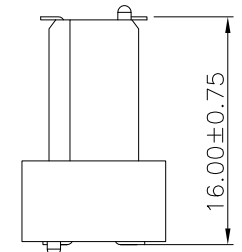
Contact Resistance: Signal Pin: 45mΩ max .

Operating Temperature: -55°C ~ +125°C .

***RoHS Compliant**

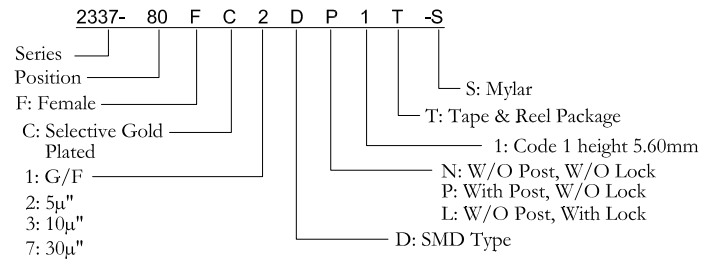


Mating With Male:
2337-80MC2DP2T-S



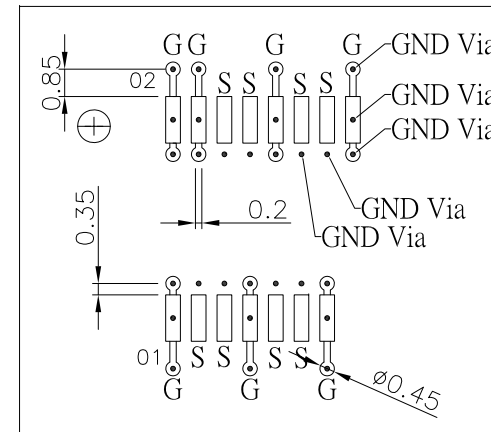
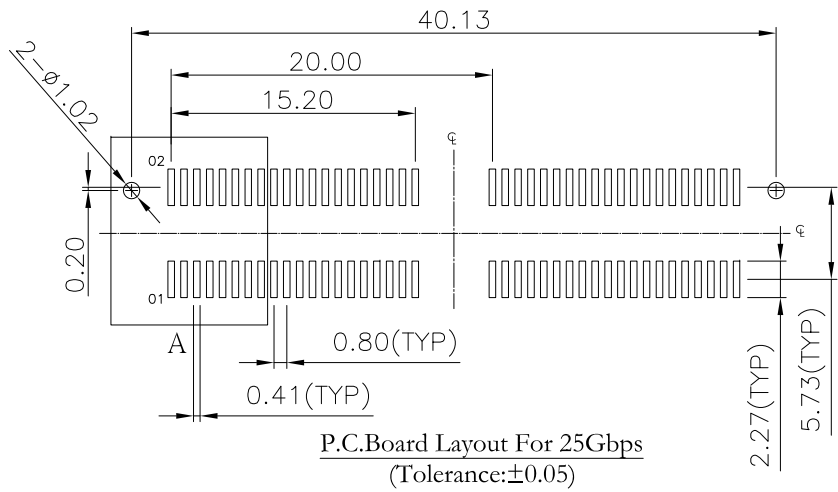
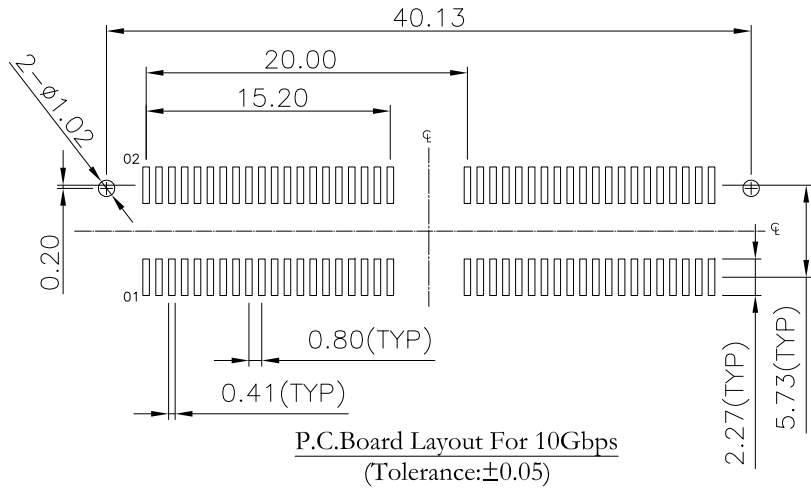
Mating With Male:
2337-Z80MC2DP1T-S

Mating Height



Tolerances	Dwg No.	2337-D0000-003	Title:		 OUPIIN ELECTRONIC(KUNSHAN) CO., LTD. P/N: 2337-80FC2DP1T-S					
x. = ±0.50	Projection		2337 Series							
.x = ±0.25	Unit	mm	Scale	1:1	High Speed Board to Board		SHEET	1/2	Ver.No.	R3
.xx = ±0.15	Drawn By	WP 01/06'24	Pitch 0.8mm							

REV.	SPECIFICATION	ECN NO.	APPD.
R3		ECN240111	



Tolerances	Dwg No.	2337-D0000-003	Title:		 OUPIIN ELECTRONIC(KUNSHAN) CO., LTD. P/N: 2337-80FC2DP1T-S					
x. = ±0.50	Projection		2337 Series							
.x = ±0.25	Unit	mm	Scale	1:1	High Speed Board to Board		SHEET	2/2	Ver.No.	R3
.xx = ±0.15	Drawn By	WP 01/06'24			Pitch 0.8mm					